DB5H411K

Silicon epitaxial planar type

For high frequency amplification DB2J411 in WSMini5 type package

■ Features

- \bullet Low forward voltage V_{F} and small reverse current I_{R}
- Short reverse recovery time t_{rr}
- Halogen-free / RoHS compliant
 (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

■ Marking Symbol: 3F

■ Basic Part Number

Dual DB2J411 (Parallel)

■ Packaging

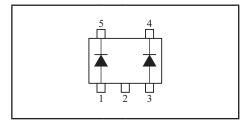
DB5H411K0L Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit
Reverse voltage		V _R	40	V
Forward current (Average)	Single	I _{F(AV)}	1	A
	Double		0.75	A
Non-repetitive peak forward surge current *1	Single	I _{FSM}	3	A
	Double		2.25	A
Junction temperature		T _j	125	°C
Storage temperature		T _{stg}	-55 to +125	°C

Note) *1: 50 Hz sine wave 1 cycle (Non-repetitive peak current)

Unit: mm 2.0 0.13 حi 2 0.7 (0.65)(0.65) 1: Anode-1 4: Cathode-2 2: N.C. 5: Cathode-1 3: Anode-2 WSMini5-F1-B Panasonic **JEITA** SC-113CA Code

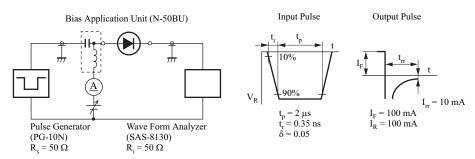


■ Electrical Characteristics $T_a = 25$ °C±3°C

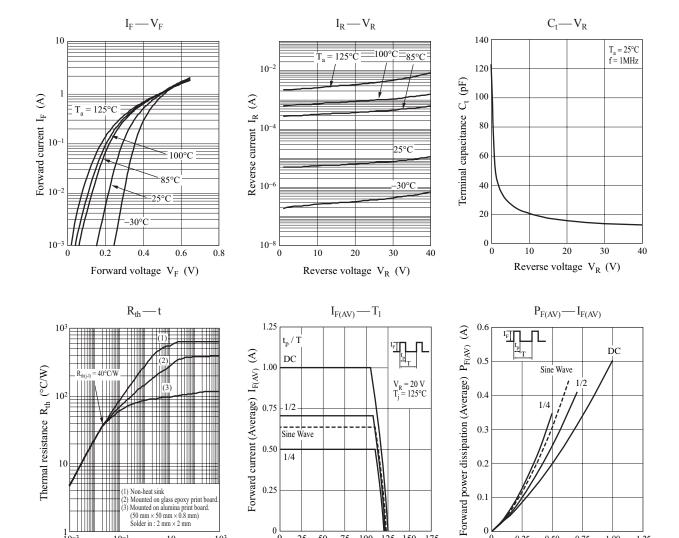
Parameter Symbol Conditions Min Unit Тур Max $I_F = 1 A$ 0.50 V Forward voltage V_{F} 0.58 Reverse current $V_R = 40 \text{ V}$ 15 100 μΑ Terminal capacitance C_t $V_R = 10 \text{ V, } f = 1 \text{ MHz}$ 21 рF Reverse recovery time *1 $I_F = I_R = 100 \text{ mA}, I_{rr} = 10 \text{ mA}$ 6.8 $t_{rr} \\$

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- 3. *1: t_{rr} measurement circuit



Panasonic



75 100

Lead temperature T_l (°C)

125 150

175

0.25

0.50

0.75

Forward current (Average) $I_{F(AV)}$ (A)

1.25

25 50

10

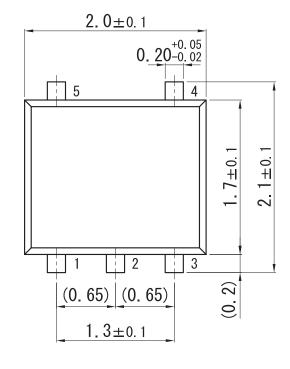
 10^{-1}

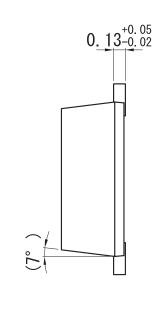
Time t (s)

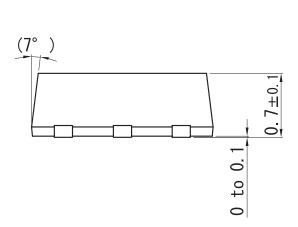
103

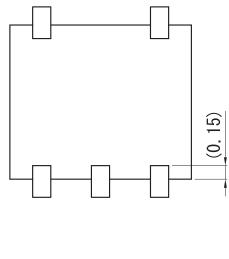
WSMini5-F1-B

Unit: mm

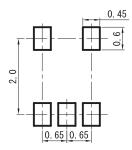








■ Land Pattern (Reference) (Unit: mm)



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